



Patent

Customer No.: 31561
 Docket No.: 10230-US-PA
 Application No.: 10/605,163

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Applicant : Wang, Sung-Fei
 Application No. : 10/605,163
 Filed : September 12, 2003
 For : SEMICONDUCTOR PACKAGE WITH A HEAT
 SPREADER
 Art Unit : 2826
 Examiner : WILLIAMS, ALEXANDER O.

TRANSMITTAL LETTER

+1-571-273-2885
 (Via fax: 1+2 pages)

Assistant Commissioner for Patents
 Alexandria, VA 22314

Dear Sir,

In response to the Notice of Allowance and Fee(s) due, dated November 4, 2005, transmitted herewith please find the Issue Fee Transmittal (PTOL-85B) in duplicate.

Please charge the fee in the amount of \$1700.00 for Issue Fee and Publication Fee to Account No. 50-2620 (Order No.: 10230-US-PA).

Please be kindly advised that the title of the invention has been amended to "SEMICONDUCTOR PACKAGE WITH A HEAT SPREADER" in the amendment and response to office action, dated June 28, 2005.

Thank you for your assistance in the subject matter. If you have any questions, please feel free to contact me.

Respectfully Submitted,
 JIANQ CHYUN Intellectual Property Office

Date: February 6, 2006

By: Belinda Lee
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